

PRODUCT SPECIFICATIONS

For Customer:			☐ : APPROVAL FOR SPECIFICATION		
Customer M	lodel No		☐ : APPROVAL FOR SAMPLE		
Module No.:	: ZBH04	3B16-15XT1	Date : 2012	.6.1	
			Version: 1.0)	
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Table of Co	ntents				
No.		Item		Page	
1	Cover She	et(Table of Contents)			
2	Revision F	Record			
3	General S	pecifications			
4	Outline Dra	nwing			
5	Absolute M	Iaximum Ratings			
6	Electrical S	pecifications and Instruction	on Code		
7	Optical Cha	aracteristics			
8	Reliability	Test Items and Criteria			
9	Quality Le	vel			
10	Packing Re	liability			
				_	
For Custon	ner's Acc	eptance:			
Approve	ed By		Comment		
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2. Revision Record

Date	Rev.No.	Page	Revision Items	Prepared
2012.6.1	V1.0		The first release	Qiu



3. General Specifications

ZBH043B16-15XT1 is a TFT-LCD module. It is composed of a TFT-LCD panel, driver IC, FPC, TP,a backlight unit. The $4.3^{\prime\prime}$ display area contains 480×272 pixels and can display up to 262K colors. This product accords with RoHS

Item	Contents	Unit	Note
LCD Type	TFT	-	
Display color	262k		1
Viewing Direction	6	O'Clock	
Operating temperature	-20~+70	$^{\circ}$ C	
Storage temperature	-30~+80	$^{\circ}\!\mathbb{C}$	
Module size	105.5(W)×67.2(H)×4.1(D)	mm	2
Active Area(W×H)	95.04X53.856	mm	
Number of Dots	480×272	dots	
Controller	HX8257A	-	
Power Supply Voltage	2.8	V	
Outline Dimensions	Refer to outline drawing	-	
Backlight	10-LEDs (white)	pcs	
Weight	~30	g	
Interface	F.P.C 0.5mm	-	

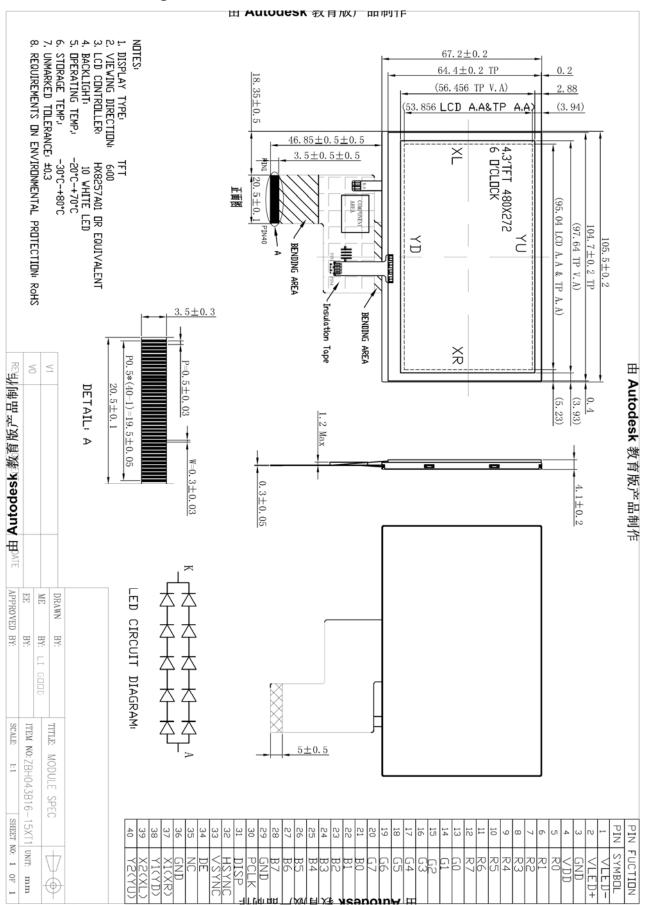
environmental criterion.

Note 1: Color tune is slightly changed by temperature and driving voltage.

Note 2: Without FPC and Solder.



4. Outline Drawing





5. Absolute Maximum Ratings(Ta=25°C)

5.1 Electrical Absolute Maximum Ratings.(Vss=0V ,Ta=25℃)

Item	Symbol	Min.	Max.	Unit	Note
Power Supply Voltage	V_{CC}	-0.3	3.0	V	
Logic Signal Input /Output Voltage	V _{IOVCC}	-0.3	V _{CC} +0.5	V	1, 2
Power Supply Voltage for LCD	Vop	0	18	V	1, 2
Current of LED	ILED	0	50	mA	

Notes:

- If the module is above these absolute maximum ratings. It may become permanently damaged.
 Using the module within the following electrical characteristic conditions are also exceeded, the module will malfunction and cause poor reliability.
- 2. $V_{CC} > V_{SS}$ must be maintained.
- 3. Please be sure users are grounded when handing LCD Module.

5.2 Environmental Absolute Maximum Ratings.

Item	Stor	age	Opera	Note	
item	MIN.	MAX.	MIN.	MAX.	Note
Ambient Temperature	-30℃	80℃	-20℃	70℃	1,2
Humidity	-	-	-	-	3

- 1. The response time will become lower when operated at low temperature.
- 2. Background color changes slightly depending on ambient temperature.

The phenomenon is reversible.

3. Ta<=40°C:85%RH MAX.

Ta>= 40° C:Absolute humidity must be lower than the humidity of 85%RH at 40° C.



6. Electrical Specifications and Instruction Code

6.1 Electrical characteristics(Vss=0V ,Ta=25℃)

Parame	ter	Symbol	Condition	Min	Тур	Max	Unit	Note
Power su	pply	VCC	Ta=25℃	2.6	2.8	3.0	V	
Input	'H'	V _{IH}	V _{CC} =2.8V	0.8V _{CC}	-	V _{CC}	V	
voltage	'L'	V _{IL}	V _{CC} =2.8V	0	-	0.2V _{CC}	V	
Current Consumption		I _{CC1}	Normal mode	-	15	30	mA	2
		I _{CC2}	Sleep mode	-	0.03	0.09	mA	2

Note:

1:When an optimum contrast is obtained in transmissive mode.

2: Tested in 1×1 chessboard pattern.

6.2 LED backlight specification(VSS=0V ,Ta=25 $^{\circ}$ C)

Ite	em	Symbol	Condition	Min	Тур	Max	Unit	Note
Supply	voltage	-	1	-	15.5	-	V	1
Supply	current	l _f	-	-	40	-	mA	2
Forward	Normal	I _{pn}	5-chip	-	20	-	A	
current	Dimming	I _{pd}	Serial x 2	-		_	mA	

Note:

1: VLED=VLED(+)-VLED(-).

2:The current of LED is 20mA.

A LED drive in constant current mode is recommended.

3: LED power consumption is around 0.132W.



6.3 Interface signals

Pin No.	Symbol	I/O	Function
1	VLED-	I	LED back light(Cathode)
2	VLED+	ı	LED back light(Anode)
3	GND		GND
4	VDD	ı	Power supply
5-12	R0~R7	I	Red data bus
13-20	G0~G7		Green data bus
21-28	B0~B7	I	Blue data bus
29	GND		GND
30	PCLK		Data clock
31	DISP		Standby mode select pin
32	HSYNC	I	Line SYNC signal
33	VSYNC		Frame SYNC signal
34	DE		Data enable pin
35	NC		
36	GND		GND
37	X1	0	
38	Y1	0	Touch Panel Control pin
39	X2	0	Touch Fanel Control pin
40	Y2	0	

7. Optical Characteristics

Item	Symbol	Condition	Min.	Тур.	Max.	Unit	Note
Brightness	Вр	<i>θ</i> =0°	280	350	-	Cd/m ²	1
Uniformity	⊿Bp	Ф=0°	70	80	-	%	1,2
	3:00		-	65	-		
Viewing	6:00	0->40	-	55	-	Deg	3
Angle	9:00	Cr≥10	-	65	-		
	12:00		-	45	-		
Contrast Ratio	Cr		200	250		-	4
Response	Response T _r	<i>θ</i> =0°	-	16	-	ms	
Time	T _f	Ф=0°	-	12	-	ms	5
NTSC Ratio	S		45	60	-	%	

Note: The parameter is slightly changed by temperature, driving voltage and materiel

Note 1: The data are measured after LEDs are turned on for 5 minutes. LCM displays full white.

The brightness is the average value of 9 measured spots. Measurement equipment

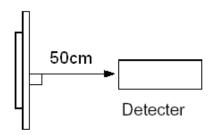


PR-705 (Φ8mm)

Measuring condition:

- Measuring surroundings: Dark room.
- Measuring temperature: Ta=25℃.
- Adjust operating voltage to get optimum contrast at the center of the display.

Measured value at the center point of LCD panel after more than 5 minutes while backlight turning on.

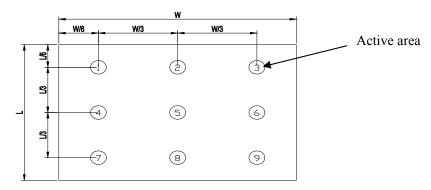


Note 2: The luminance uniformity is calculated by using following formula.

$$\triangle$$
Bp = Bp (Min.) / Bp (Max.)×100 (%)

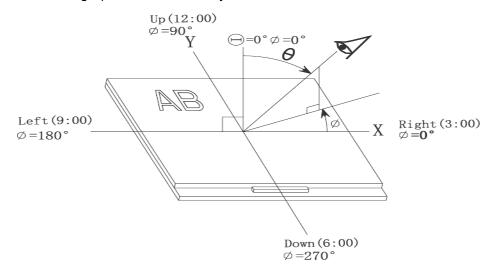
Bp (Max.) = Maximum brightness in 9 measured spots

Bp (Min.) = Minimum brightness in 9 measured spots.



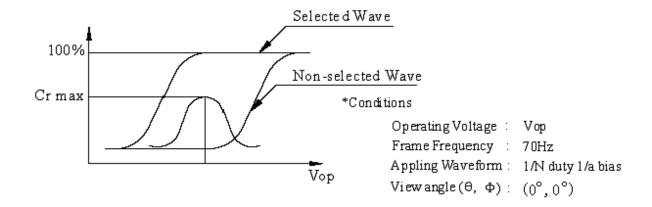
Note 3: The definition of viewing angle:

Refer to the graph below marked by θ and Φ





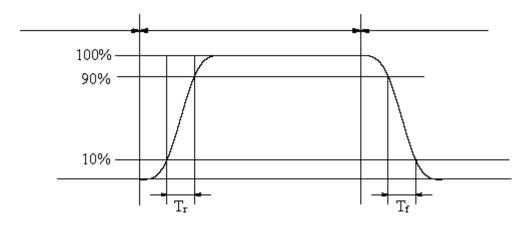
Note 4: Definition of contrast ratio.(Test LCD using DMS501)



Contrast
$$ratio(Cr) = \frac{Brightness\ of\ selected\ dots}{Brightness\ of\ non-selected\ dots}$$

Note 5: Definition of Response time. (Test LCD using DMS501):

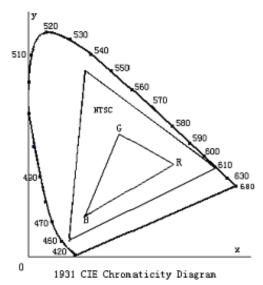
The output signals of photo detector are measured when the input signals are changed from "black" to "white" (falling time) and from "white" to "black" (rising time), respectively. The response time is defined as the time interval between the 10% and 90% of amplitudes. Refer to figure as below.



The definition of response time

Note 6: Definition of Color of CIE Coordinate and NTSC Ratio.



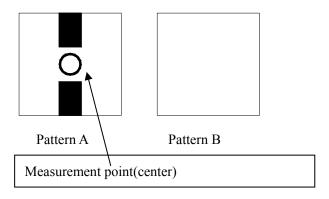


Color gamut:

$$S = \frac{area~of~RGB~triangle}{area~of~NTSC~triangle} \times 100\%$$

Note 7: Definition of cross talk.

Cross talk ratio(%)=|pattern A Brightness-pattern B Brightness|/pattern A Brightness*100



Electric volume value=3F+/-3Hex

8. Reliability Test Items and Criteria

No	Test Item	Test condition	Criterion
1	High Temperature Storage	80°C±2°C 96H Restore 2H at 25°C Power off	After testing, cosmetic and electrical
2	Low Temperature Storage	-30℃±2℃ 96H Restore 2H at 25℃ Power off	defects should not happen. 2. Total current
3	High Temperature Operation	70°C±2°C 96H Restore 2H at 25°C Power on	consumption should not be more than twice of initial value.



4	Low Temperature Operation	-20℃±2℃ 96H Restore 4H at 25℃	
		Power on	
5	High Temperature/Humidity	60℃±2℃ 90%RH 96H	
	Operation	Power on	
6	Temperature Cycle	30min 5min 30min after 5 cycle, Restore 2H at 25°C Power off	
7	Vibration Test	10Hz~150Hz, 100m/s ² , 120min	Not allowed cosmetic
8	Shock Test	Half- sine wave,300m/s ² ,11ms	and electrical defects.

Note: Operation: Supply 2.8V for logic system.

The inspection terms after reliability test, as below

ITEM	Inspection
Contrast	CR>50%
IDD	IDD<200%
Brightness	Brightness>60%
Color Tone	Color Tone+/-0,05

9 Quality level

9.1 Classification of defects

Major defects (MA): A major defect refers to a defect that may substantially degrade usability for product applications, including all functional defects(such as no display, abnormal display, open or missing segment, short circuit, missing component), outline dimension beyond the drawing, progressive defects and those affecting reliability.

Minor defects (MI): A minor defect refers to a defect which is not considered to be able to substantially degrade the product application or a defect that deviates from existing standards almost unrelated to the effective use of the product or its operation, such as black spot, white spot, bright spot, pinhole, black line, white line, contrast variation, glass defect, polarizer defect, etc.



9.2 Definition of inspection range

For dot defect of TFT LCD which is not smaller than 3 inches, dividing three areas to make a judgment (according to figure 1).

A area : center of viewing area

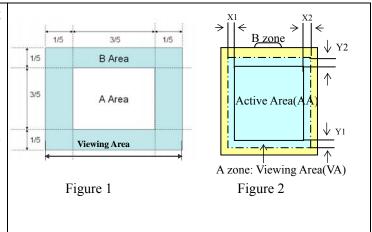
B area : periphery of viewing area

C area: Outside viewing area

For other defects, dividing two areas to make a judgment (according figure 2).

A zone : Inside Viewing area B zone : Outside Viewing area

X1(A.A~V.A): 2mm X2(A.A~V.A): 2mm Y1(A.A~V.A): 2mm Y2(A.A~V.A): 2mm



9.3 Inspection items and general notes

9.5 111	9.3 inspection items and general notes						
General notes	①Should any defects which are not specified in this standard happen, additional standard shall be determined by mutual agreement between customer and TIANMA. ②Viewing area should be the area which TIANMA guarantees. ③Limit sample should be prior to this Inspection standard. ④Viewing judgment should be under static pattern. ⑤Inspection conditions Inspection distance: 250 mm (from the sample) Inspection angle : 45 degrees in 12 o'clock direction (all defects in viewing area should be inspected from this direction)						
	Pinhole, Bright spot, Black spot, White spot, Black line, White Line, Foreign particle, Bubble	The color of a small area is different from the remainder. The phenomenon doesn't change with voltage					
	Contrast variation	The color of a small area is different from the remainder. The phenomenon changes with voltage					
Inspection	Polarizer defect	Scratch, Dirt, Particle, Bubble on polarizer or betwee polarizer and glass					
items	Dot defect (TFT LCD)	The pixel appears bright or dark abnormally when displa					
	Functional defect	No display, Abnormal display, Open or missing segment, Short circuit, False viewing direction					
	Glass defect	Glass crack, Shaved corner of glass, Surplus glass					
	PCB defect	Components assembly defect					

9.4 Outgoing Inspection level

Outgoing Inspection	Inspection conditions	Inspection				
standard	mopositori conditiono	Min.	Max.	Unit	IL	AQL
Major Defects See 8.3 general notes		See 8.5		Ш	0.065	



Minor Defects	See 8.3 general notes	See 8.5	II	0.065		
Note: Sampling standard conforms to GB2828						

9.5 Inspection Items and Criteria

		Judgment standard						
Inspection items			Category		Acceptable number			
					A zone	B zone		
				Ф<=0.10	Neglected			
	Black spot, White spot,	, iole, Foreign	В	0.10<Ф<=0.2	1	Neglected		
1	Pinhole, Foreign Particle, Particle		С	0.2<Ф	0			
	in or on glass, Scratch on glass	$\Phi = (a+b)/2(m$	D	-	-			
			Total defective point(B,C)		1			
		4	Α	W<=0.02	Neglected			
	Black line, White line, and Particle Between Polarizer and glass, Scratch on glass	White Width		0.02 <w<=0.03 L<=1.0</w<=0.03 	1			
2		n and L:Length(mm)	С	0.03 <w<=0.05 L>1.0</w<=0.05 	0	Neglected		
			D 0.05 <w, 1.0<l<="" td=""><td>0</td><td rowspan="2">_</td></w,>		0	_		
				tal defective point(B,C)	1			
3	3 Bright spot		any size		none	none		
	Contrast variation			Φ<0.2	Neglected			
		$ \begin{array}{c c} & b \\ \hline & \\ & \\ & \\ & \\ & \\ & \\ & \\ $	В	0.2<Ф<=0.3	2	Neglecte d		
4			С	0.3<Ф<=0.4	1			
			D	D 0.4<Φ 0				
				tal defective point(B,C)	3			
5	Bubble inside cell		any size		none	none		
6	Polarizer defect (if Polarizer is			fer to item 1 and item 2.				
	useu)			Ф<=0.1	Neglected	Neglecte d		



			В	0.1 <Ф<=0.2	1		
				0.1 14 1-0.2	ı		
			С	0.2 <Ф	0		
		Stage surplus glass	B<:	=0.3mm			
7	Surplus glass	Surrounding surplus glass	Should not influence outline dimension and assembling.			embling.	
8	8 Open segment or open common		Not permitted				
9	Short circuit		Not permitted				
10	False viewing direction		Not permitted				
11	Contrast ratio uneven		According to the limit specimen				
12	Crosstalk		According to the limit specimen				
13	Black /White spot(display)		Refer to item 1				
14	Black /White line(display)		Refer to item 2				



			Judgment standard	
Inspection items			Category(application: B zone)	Acceptable number
	i) The front of lead terminals	Α	a≤ t, b≤1/5W, c≤3mm	
	w t	В	Crack at two sides of lead terminals should not cover patterns and alignment mark	
Glass defect crack	Inner border line of the seal Outer border line of the seal	b <	Inner borderline of the seal	Max.3
	Inner border line of the seal Outer border line of the seal	b <	Outer borderline of the seal	defects allowed
	iv) Corner	Α	a <= t, b <= 3.0, c <= 3.0	
	w b c		Glass crack should not cover patterns u and alignment mark and patterns.	
	defect	ii) Surrounding crack-non-contact side seal Inner border line of the seal Outer border line of the seal iii) Surrounding crack- contact side seal Inner border line of the seal Outer border line of the seal iv) Corner	i) The front of lead terminals A B ii) Surrounding crack-non-contact side seal C b a t b c c c b a t c c c c c c c c c c c c c c c c c c	Inspection items Category(application: B zone) i) The front of lead terminals A a≤t, b≤1/5W, c≤3mm B Crack at two sides of lead terminals should not cover patterns and alignment mark ii) Surrounding crack-non-contact side seal C b a b Inner border line of the seal Outer border line of the seal Outer border line of the seal iii) Surrounding crack-contact side seal iii) Surrounding crack-contact side seal iii) Surrounding or ack-contact side seal A a <= t, b <= 3.0, c <= 3.0 B Glass crack should not cover patterns u and alignment mark and patterns.



Inspection items			Judgment standard		
			Category(application: B zone)		
	РСВ	Component soldering: No cold soldering, short, open circuit, burr, tin ball The flat encapsulation component position deviation must be less than 1/3 width of the pin (Pic.1); the sheet component deviation: Pin deviates from the pad and contact with the near components is not permitted (Pic.2) lead defect: The lead lack must be less than 1/3 of its width; The lead burr must be less than 1/3 of the seam; Impurities connect with the near leads is not permitted	Component Soldering pad Lead L2>0 L1>0		
16	defect	Connector soldering: Soldering tin is at contact position of the plug and socket is not permitted No foundation is scald Serious cave distortion on plug and socket contact pin is not permitted Glue on root of the speaker receiver and	Soldering tin is not permit in this area Soldering tin is not permit in this area Socket Base Board		
		motor lead: The insulative coat of the lead must join into the PCB; the protected glue must envelop to the insulative coat.	Glue Lead PCB Insulative coat		



10. Precautions for Use of LCD Modules

10.1 Handling Precautions

- 9.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- 9.1.2 If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
- 9.1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- 9.1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- 9.1.5 If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:
 - Isopropyl alcohol
 - Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

- Water
- Ketone
- Aromatic solvents
- 9.1.6 Do not attempt to disassemble the LCD Module.
- 9.1.7 If the logic circuit power is off, do not apply the input signals.
- 9.1.8 To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - a. Be sure to ground the body when handling the LCD Modules.
 - b. Tools required for assembly, such as soldering irons, must be properly ground.
 - c. To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.



d. The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.

10.2 Storage precautions

- 9.2.1 When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.
- 9.2.2 The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:

Temperature : 0° C $\sim 40^{\circ}$ C

Relatively humidity: ≤80%

- 9.2.3 The LCD modules should be stored in the room without acid, alkali and harmful gas.
- 10.3 The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.